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#### February 2015

# **FPF2498** Adjustable OVP with 28 V Input OVT Load Switch

#### **Features**

Function	Advanced Load Switch		
Input	3.5 – 12 V		
Features	28 V Absolute Ratings on VIN 1.7 A Maximum Continuous Current Capability 80 mΩ R <sub>ON</sub> Typical Over-Voltage Protection (OVP) Over-Current Protection (OCP) Thermal Shutdown Under-Voltage Lockout (UVLO) Reverse Current Blocking (RCB)		
ESD	15 kV IEC 61000-4-2 Air Gap		
Operating Temperature Range	-40 to +85°C		
Package	6-Ball WLCSP (1.05 x 1.3 x 0.625 mm, 0.4 mm Pitch)		
Ordering Information	FPF2498BUCX		
Top Mark	ТК		

### Description

The FPF2498 advanced load-management switch targets applications requiring a highly integrated solution. It disconnects loads powered from the DC power rail (<12 V) with stringent off-state current targets and high load capacitances (<100 µF). The FPF2498 consists of a slew-rate controlled low-impedance MOSFET switch. FPF2498 has over-voltage protection and over-temperature protection.

## **Applications**

- Cellular Phones, Smart Phones
- Tablets

### **Related Resources**

FPF2498 Evaluation Board



#### Note:

Recommend  $C_{LOAD}$  value be larger than 2.2 µf. 1.



# Pin Map

Name	Pin #	Туре	Default State		Description		
VIN	A2	Input	N/A	Input voltage path			
VOUT	B1	Output	N/A	Output voltage path			
ON	B2	loput	LOW	On / Off control of device		On / Off control of douise	Enabled
ON	DZ	Input	LOW			Disabled	
OVLO	C1	Input		OVP Adjustment set by R1 and R2 and is compared to 1.2 V – V <sub>IN</sub> × R2 / (R1+R2) >1.2 V			
FLAGB	C2	Open- Drain Output	High-Z	Indicates a OVP / OCP / LOW / GND OVP (over 6.5 V OCP (over 2 A)		Active – Indicates: OVP (over 6.5 V at 3 – 6 V) OCP (over 2 A) OTP (over 150°C)	
					HIGH / V_IO	Normal Operation	
GND	A1	GND	GND	Device ground			

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters			Max.	Unit
	Voltage on VIN to GND, VIN to VOUT, OVLO Pins				
V <sub>PIN</sub>	Voltage on ON, FLAGB Pins	Voltage on ON, FLAGB Pins			
	Voltage on VOUT to GND Pins		-0.3	20.0	
I <sub>SW</sub>	Maximum Switch Current			1.75	А
t <sub>PD</sub>	Total Power Dissipation at $T_A=25^{\circ}C$			1	W
TJ	Operating Junction Temperature		-40	+150	°C
T <sub>STG</sub>	Storage Junction Temperature		-65	+150	°C
Θја	Thermal Resistance, Junction-to-Ambient (1-inch Square Pad of 2 oz. Copper)			95 <sup>(2)</sup> 110 <sup>(3)</sup>	°C/W
	Electrostatic Discharge Capability	Human Body Model, ANSI / ESDA / JEDEC JS-001-2012	3		
ESD		Charged Device Model, JESD22-C101	2		kV
	IEC61000.4.2 System Lovel	Air Discharge (VIN, VON, VOUT to GND)	15		
	IEC61000-4-2 System Level	Contact Discharge ( $V_{IN}$ , $V_{ON}$ , $V_{OUT}$ to GND)	8		

Notes:

2. Measured using 2S2P JEDEC std. PCB.

3. Measured using 2S2P JEDEC PCB cold plate method.

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Symbol Parameters		Max.	Unit
V <sub>IN</sub>	V <sub>IN</sub> Supply Voltage		12.0	V
I <sub>SW</sub>	I <sub>SW</sub> Maximum Continues Switch Current <sup>(4)</sup>		1.7	А
T <sub>A</sub>	Ambient Operating Temperature	-40	85	°C

Note:

4. Maximum Junction Temperature = 85°C

Unless otherwise noted;  $V_{IN}$ =3.5 to 5.5 V,  $T_A$ =-40 to +85°C; typical values are at  $V_{IN}$ =5 V and  $T_A$ =25°C.

**Electrical Characteristics** 

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Basic Opera	ation		•	•		
I <sub>SD(OFF)</sub>	Shutdown Current	V <sub>IN</sub> =5.5 V, V <sub>OUT</sub> =0 V, V <sub>ON</sub> =GND		0.4	3.0	μA
ΙQ	Quiescent Current	V <sub>IN</sub> =5.5 V, V <sub>OUT</sub> =Floating, I <sub>OUT</sub> =0 mA		90	125	μA
		V <sub>IN</sub> =3.7 V, I <sub>OUT</sub> =200 mA		90		<sub>5(5)</sub> mΩ
P		V <sub>IN</sub> =5.0 V, I <sub>OUT</sub> =200 mA			95 <sup>(5)</sup>	
R <sub>ON</sub>	On Resistance	V <sub>IN</sub> =9 V, I <sub>OUT</sub> =200 mA		80		
		V <sub>IN</sub> =12 V, I <sub>OUT</sub> =200 mA				
VIH	ON Input Logic HIGH Voltage	V <sub>IN</sub> =3.5 V to 5.5 V	1.15			V
V <sub>IL</sub>	ON Input Logic LOW Voltage	V <sub>IN</sub> =3.5 V to 5.5 V			0.65	V
Vol_flag	FLAGB Output Logic LOW Voltage	V <sub>IN</sub> =5 V, I <sub>SINK</sub> =1 mA		0.10	0.20	V
I <sub>FLAGB_LK</sub>	FLAGB Output HIGH Leakage Current	V <sub>IN</sub> =5 V, Switch On			0.5	μA
RPD	Pull-Down Resistance on ON Pin	V <sub>IN</sub> =5 V, OVLO=GND		3		M
Over-Voltag	je Protection					
	Default Input OVP Lockout	VIN Rising Threshold OVLO=GND	6.2	6.5	6.8	
V <sub>OV_TRIP</sub>		VIN Falling Threshold OVLO=GND		6.2		V
Vovlo_sel	Voltage threshold for OVLO selection	V <sub>IN</sub> =3.5 V to 5.5 V, OVLO=GND		0.3		١
V <sub>OVP_HYS</sub>	Input OVP Hysteresis	V <sub>IN</sub> Falling Threshold OVLO=External Setting		0.3		V
V <sub>OVLO_TH</sub>	OVLO Set Threshold	VIN=3.5 to VOVLO		1.20		V
t <sub>OVP</sub>	Response Time	$I_{OUT}$ =0.5 A, C <sub>L</sub> =0 µF, T <sub>A</sub> =25°C, V <sub>IN</sub> =6 V to 7 V		0.5	1	μ
		V <sub>IN</sub> Rising		3.2		Ι.
V <sub>UVLO</sub>	Under-Voltage Lockout	V <sub>IN</sub> Falling		3.0		V
VUVLO_HYS	UVLO Hysteresis			200		m
I <sub>RCB</sub>	RCB Current	V <sub>ON</sub> =0 V, V <sub>OUT</sub> =5.5 V, V <sub>IN</sub> =0 V		2	5	μ
		Shutdown Threshold		150		
TSD	Thermal Shutdown	Return from Shutdown		130		°(
		Hysteresis		20		
Over-Currei	nt Protection					
I <sub>OCP</sub>	Over-Current Protection Trip Point	I <sub>SW</sub> > I <sub>OCP</sub>		2		ļ
Dynamic Ch	naracteristics				10	
t <sub>DON</sub>	Turn-On Delay <sup>(7)</sup>			4.3		m
t <sub>R</sub>	V <sub>OUT</sub> Rise Time <sup>(7)</sup>			3.0		m
t <sub>ON</sub>	Turn-On Time <sup>(8)</sup>	V <sub>IN</sub> =5 V, R <sub>L</sub> =100 Ω, C <sub>L</sub> =10 μF,		7.3		m
t <sub>DOFF</sub>	Turn-Off Delay <sup>(6,7)</sup>	$T_{A}=25^{\circ}C$		600		μ
t <sub>F</sub>	$V_{OUT}$ Fall Time <sup>(6,7)</sup>			2.0		m
t <sub>OFF</sub>	Turn-Off Time <sup>(6,9)</sup>	1		2.5		m
t <sub>READY</sub>	Time for Device Ready for Large Load Current <sup>(10)</sup>	С <sub>L</sub> =10 µF		5		m

FPF2498 — Adjustable OVP with 28 V Input OVT Load Switch

# **Electrical Characteristics**

Unless otherwise noted;  $V_{IN}$ =3.5 to 5.5 V,  $T_A$ =-40 to +85°C; typical values are at  $V_{IN}$ =5 V and  $T_A$ =25°C.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
t <sub>restart</sub>	Over-Current Blanking Time <sup>(6)</sup>	V <sub>IN</sub> =5 V I <sub>OUT</sub> ≥ 1.7 A		64		ms
t <sub>OCP</sub>	Over-Current Response Time <sup>(6)</sup>	Moderate Over-Current Condition; $I_{OUT} \ge I_{LIM} V_{OUT} \le V_{IN}$		4		μs
t <sub>HOCP</sub>	Hard Over-Current Response Time	Moderate Over-Current Condition; I <sub>OUT</sub> ≥ I <sub>LIM</sub> V <sub>OUT</sub> ≤ 0 V		3		μs
t <sub>FLAGB_Release</sub>	Over-Current/Voltage/Temp. Flag Release Time <sup>(6)</sup>	Time for Flag to Release when Fault Condition Removed		100		ms

#### Notes:

- 5. T<sub>A</sub>=25°C.
- 6. This parameter is guaranteed by design and characterization; not production tested.
- 7.  $t_{DON}/t_{DOFF}/t_R/t_F$  are defined in figure below.
- 8.  $t_{ON}=t_R + t_{DON}$ .
- 9.  $t_{OFF}=t_F + t_{DOFF}$ .
- 10. After  $t_{READY}$ , the device is ready for maximum DC current load condition.



# **Operation and Application Description**

#### **Input Capacitor**

To limit the voltage drop on the input supply caused by transient inrush current when the switch turns on into discharge load capacitor; a capacitor must be placed between the VIN and GND pins. A high-value  $C_{IN}$  capacitor can be used to reduce the voltage drop in high-current applications.

#### **Output Capacitor**

An output capacitor should be placed between the VOUT and GND pins. This capacitor prevents parasitic board inductance from forcing  $V_{OUT}$  below ground when the switch is on. This capacitor also prevents reverse inrush current from creating a voltage spike that could damage the device in the case of a  $V_{OUT}$  short.

#### **Fault Reporting**

Upon the detection of an over-voltage, over-current, or over-temperature condition, the FLAGB signals the fault by activating LOW.

#### Under-Voltage Lockout (UVLO)

The under-voltage lockout turns the switch off if the input voltage drops below the lockout threshold. With the ON pin active, the input voltage rising above the UVLO threshold releases the lockout and enables the switch.

#### **Over-Voltage Lockout (OVLO)**

The OVLO pin sets the over-voltage lockout trip point with a resistor-divider network. OVLO adjustment is set by R1 and R2 and is compared to  $1.2 \text{ V} - \text{V}_{\text{IN}} \times \text{R2} / (\text{R1+R2}) > 1.2 \text{ V}$ . when  $\text{V}_{\text{IN}} > \text{V}_{\text{OVLO}}$  the switch turns off to ensure protection to devices connected to VOUT. A 1 M $\Omega$  or larger resistor is recommended on R1 to reduce standby power consumption. To use the default values of 5.8 V for V<sub>OVLO</sub>, connect the OVLO pin directly to GND.

### **Package Specific Dimensions**

#### **Reverse-Current Blocking (RCB)**

The reverse-current blocking feature protects the input source against current flow from output to input. When the load switch is OFF, no current flows from the output to input.

#### **Thermal Shutdown (TSD)**

Thermal shutdown protects the die from internally or externally generated excessive temperature. During an over-temperature condition, the switch is turned off. The switch automatically turns on again if the temperature of the die drops below the threshold temperature.

#### **Current Limit**

The current limit ensures that the current flow though the switch doesn't exceed a maximum value, which can damage the device. If the current flow though the switch exceeds the trip point, the switch turns off and enters the blanking time. After the blanking time, the switch is re-enabled and checks if the fault still exists.

#### **Board Layout**

For best performance, all traces should be as short as possible. The input and output capacitors should be placed close to the device to minimize the effect that parasitic trace inductance may have on normal and short-circuit operation. Using wide traces for VIN, VOUT, GND minimizes parasitic electrical effects along with minimizing the case-to-ambient thermal impedance.

D	E	X	Y
1.300±0.030	1.050±0.030	0.325	0.250



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